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April 1st, 2010
Renesas Electronics Corporation

Issued by: Renesas Electronics Corporation (<http://www.renesas.com>)

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RQK0604IGDQA

Silicon N Channel MOS FET
Power Switching

REJ03G1496-0100

Rev.1.00

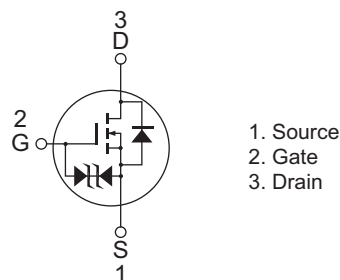
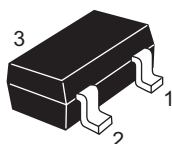
Jan 15, 2007

Features

- Low on-resistance
 $R_{DS(on)} = 111 \text{ m}\Omega$ typ.(at $V_{GS} = 4.5 \text{ V}$, $I_D = 1 \text{ A}$)
- Low drive current
- High speed switching
- $V_{DSS} \geq 60 \text{ V}$ and capable of 2.5 V gate drive

Outline

RENESAS Package code: PLSP0003ZB-A
(Package name: MPAK)



Note: Marking is "IG".

Absolute Maximum Ratings

($T_a = 25^\circ\text{C}$)

Item	Symbol	Ratings	Unit
Drain to source voltage	V_{DSS}	60	V
Gate to source voltage	V_{GSS}	± 12	V
Drain current	I_D	2	A
Drain peak current	$I_{D(pulse)}$ ^{Note1}	8	A
Body - drain diode reverse drain current	I_{DR}	2	A
Channel dissipation	P_{ch} ^{Note2}	0.8	W
Channel temperature	T_{ch}	150	$^\circ\text{C}$
Storage temperature	T_{stg}	-55 to +150	$^\circ\text{C}$

Notes: 1. $PW \leq 10 \mu\text{s}$, Duty cycle $\leq 1\%$

2. When using the glass epoxy board (FR-4 40 × 40 × 1 mm)

Electrical Characteristics

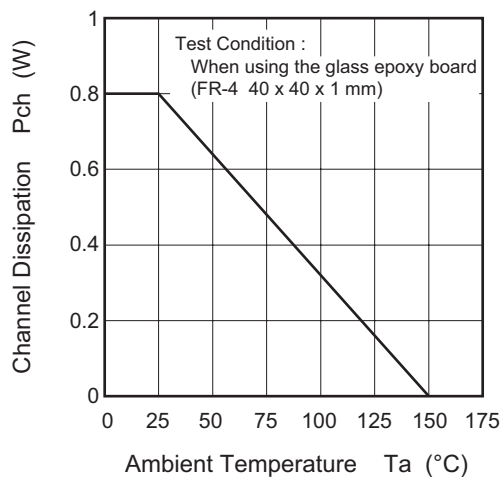
(Ta = 25°C)

Item	Symbol	Min	Typ	Max	Unit	Test conditions
Drain to source breakdown voltage	$V_{(BR)DSS}$	60	—	—	V	$I_D = 10 \text{ mA}$, $V_{GS} = 0$
Gate to source breakdown voltage	$V_{(BR)GSS}$	+12	—	—	V	$I_G = +100 \text{ } \mu\text{A}$, $V_{DS} = 0$
Gate to source breakdown voltage	$V_{(BR)GSS}$	-12	—	—	V	$I_G = -100 \text{ } \mu\text{A}$, $V_{DS} = 0$
Gate to source leak current	I_{GSS}	—	—	+10	μA	$V_{GS} = +10 \text{ V}$, $V_{DS} = 0$
Gate to source leak current	I_{GSS}	—	—	-10	μA	$V_{GS} = -10 \text{ V}$, $V_{DS} = 0$
Drain to source leak current	I_{DSS}	—	—	1	μA	$V_{DS} = 60 \text{ V}$, $V_{GS} = 0$
Gate to source cutoff voltage	$V_{GS(off)}$	0.4	—	1.4	V	$V_{DS} = 10 \text{ V}$, $I_D = 1 \text{ mA}$
Drain to source on state resistance	$R_{DS(on)}$	—	111	144	$\text{m}\Omega$	$I_D = 1 \text{ A}$, $V_{GS} = 4.5 \text{ V}$ ^{Note3}
Drain to source on state resistance	$R_{DS(on)}$	—	129	180	$\text{m}\Omega$	$I_D = 1 \text{ A}$, $V_{GS} = 2.5 \text{ V}$ ^{Note3}
Forward transfer admittance	$ y_{fs} $	3	6	—	S	$I_D = 1 \text{ A}$, $V_{DS} = 10 \text{ V}$ ^{Note3}
Input capacitance	C_{iss}	—	320	—	pF	$V_{DS} = 10 \text{ V}$ $V_{GS} = 0$ $f = 1 \text{ MHz}$
Output capacitance	C_{oss}	—	38	—	pF	
Reverse transfer capacitance	C_{rss}	—	20	—	pF	
Turn - on delay time	$t_{d(on)}$	—	12	—	ns	$I_D = 1 \text{ A}$ $V_{GS} = 10 \text{ V}$ $R_L = 10 \text{ } \Omega$ $R_g = 4.7 \text{ } \Omega$
Rise time	t_r	—	35	—	ns	
Turn - off delay time	$t_{d(off)}$	—	36	—	ns	
Fall time	t_f	—	3.7	—	ns	
Total gate charge	Q_g	—	3.4	—	nC	$V_{DD} = 10 \text{ V}$ $V_{GS} = 4.5 \text{ V}$ $I_D = 2 \text{ A}$
Gate to Source charge	Q_{gs}	—	0.6	—	nC	
Gate to drain charge	Q_{gd}	—	1.0	—	nC	
Body - drain diode forward voltage	V_{DF}	—	0.8	—	V	$I_F = 2 \text{ A}$, $V_{GS} = 0$ ^{Note3}

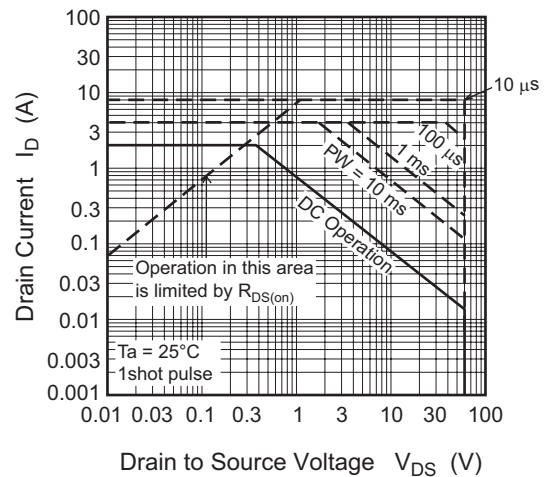
Notes: 3. Pulse test

Main Characteristics

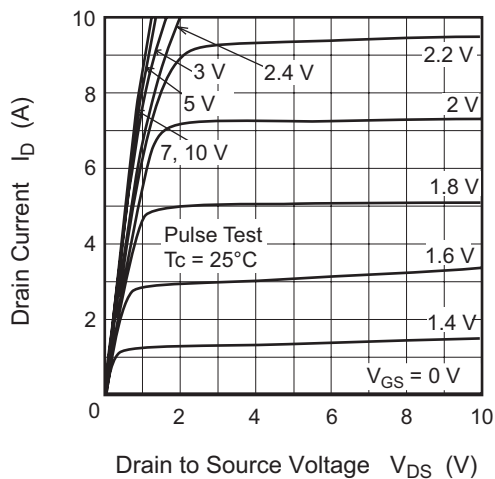
Power vs. Temperature Derating



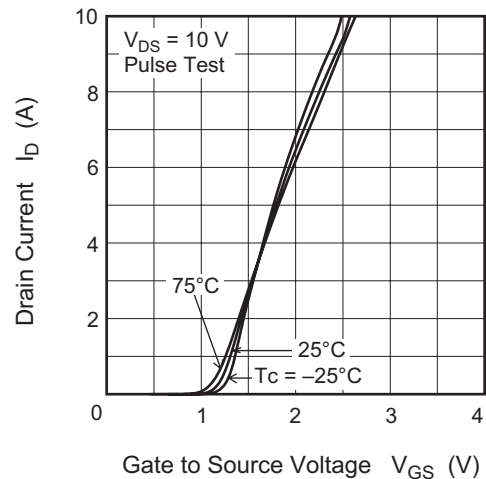
Maximum Safe Operation Area



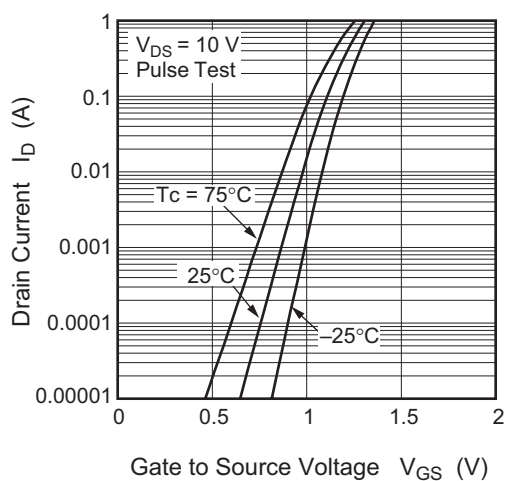
Typical Output Characteristics



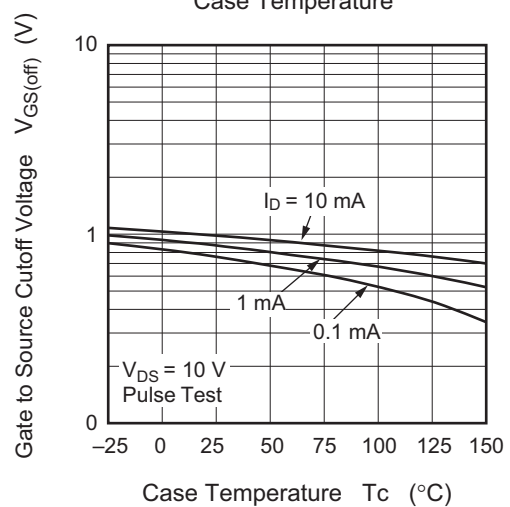
Typical Transfer Characteristics (1)

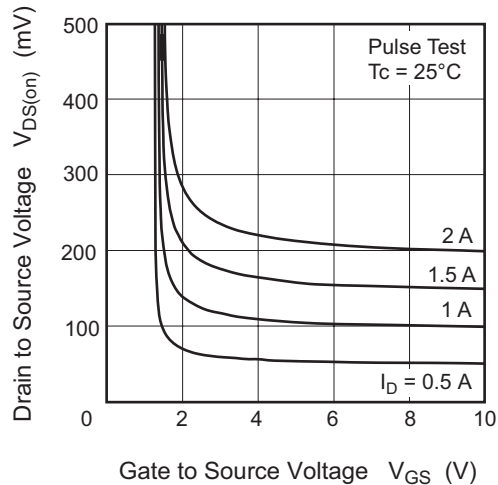
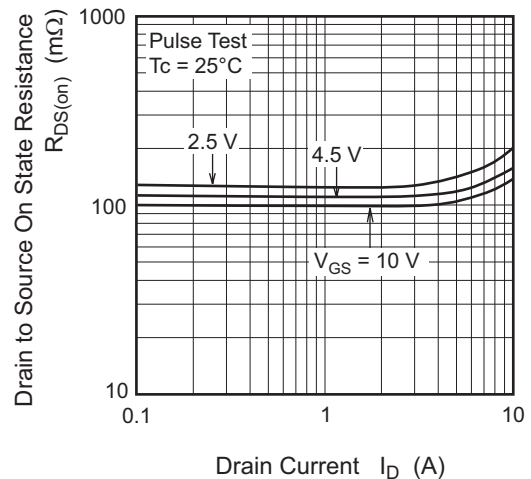
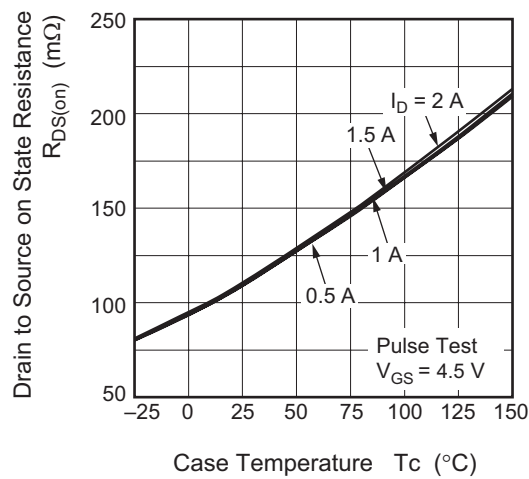
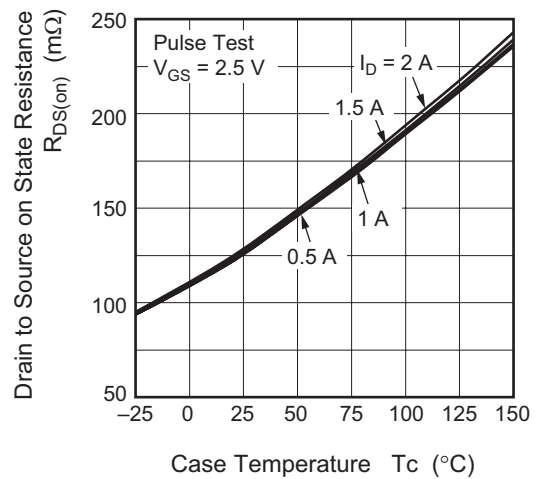
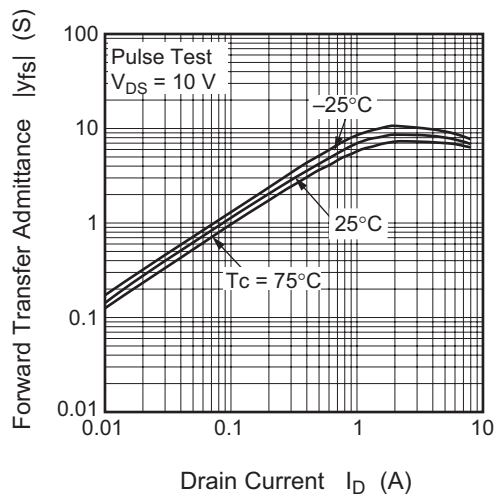
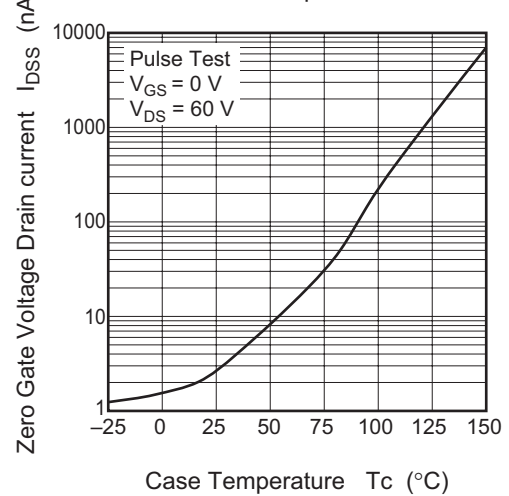


Typical Transfer Characteristics (2)

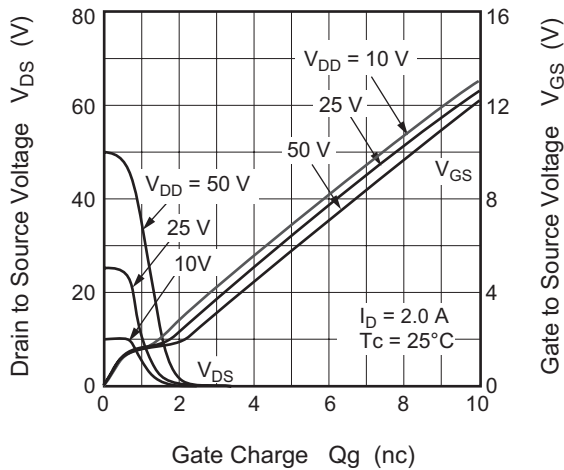


Gate to Source Cutoff Voltage vs. Case Temperature

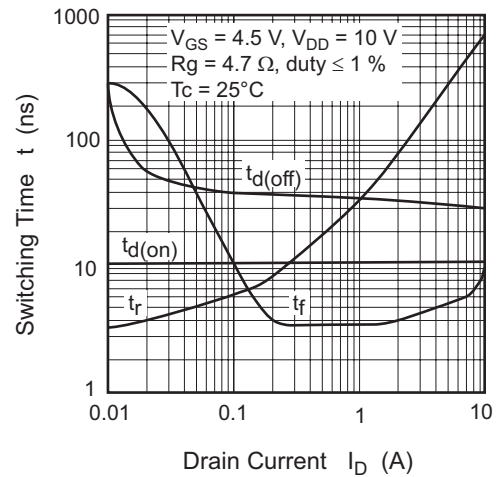


Drain to Source Saturation Voltage vs.
Gate to Source VoltageStatic Drain to Source on State Resistance
vs. Drain CurrentStatic Drain to Source on State Resistance
vs. Case Temperature (1)Static Drain to Source on State Resistance
vs. Case Temperature (2)Forward Transfer Admittance vs.
Drain CurrentZero Gate Voltage Drain current vs.
Case Temperature

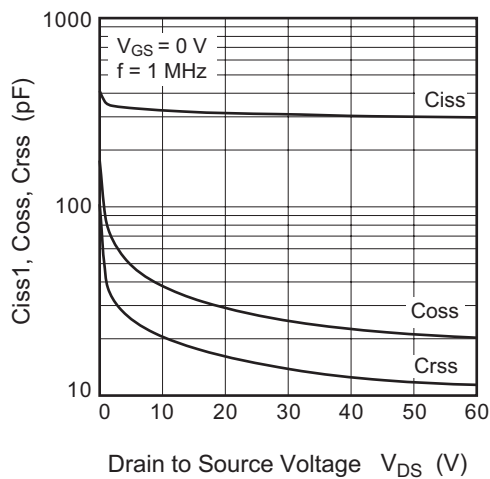
Dynamic Input Characteristics



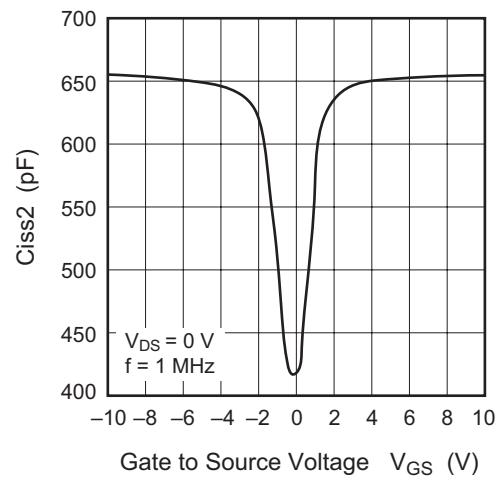
Switching Characteristics



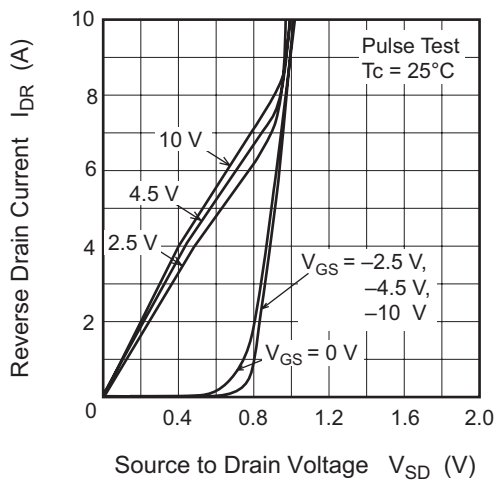
Typical Capacitance vs. Drain to Source Voltage



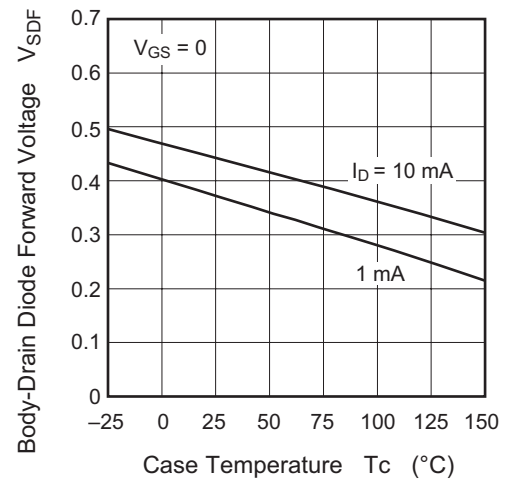
Input Capacitance vs. Gate to Source Voltage



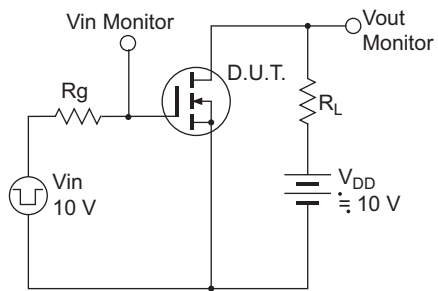
Reverse Drain Current vs. Source to Drain Voltage



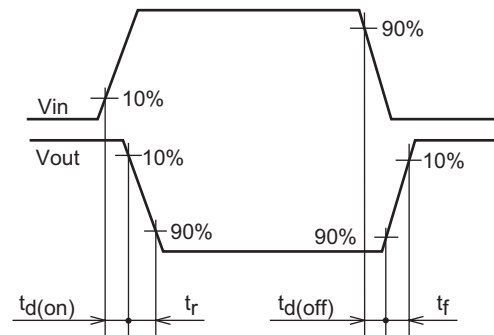
Body-Drain Diode Forward Voltage vs. Case Temperature



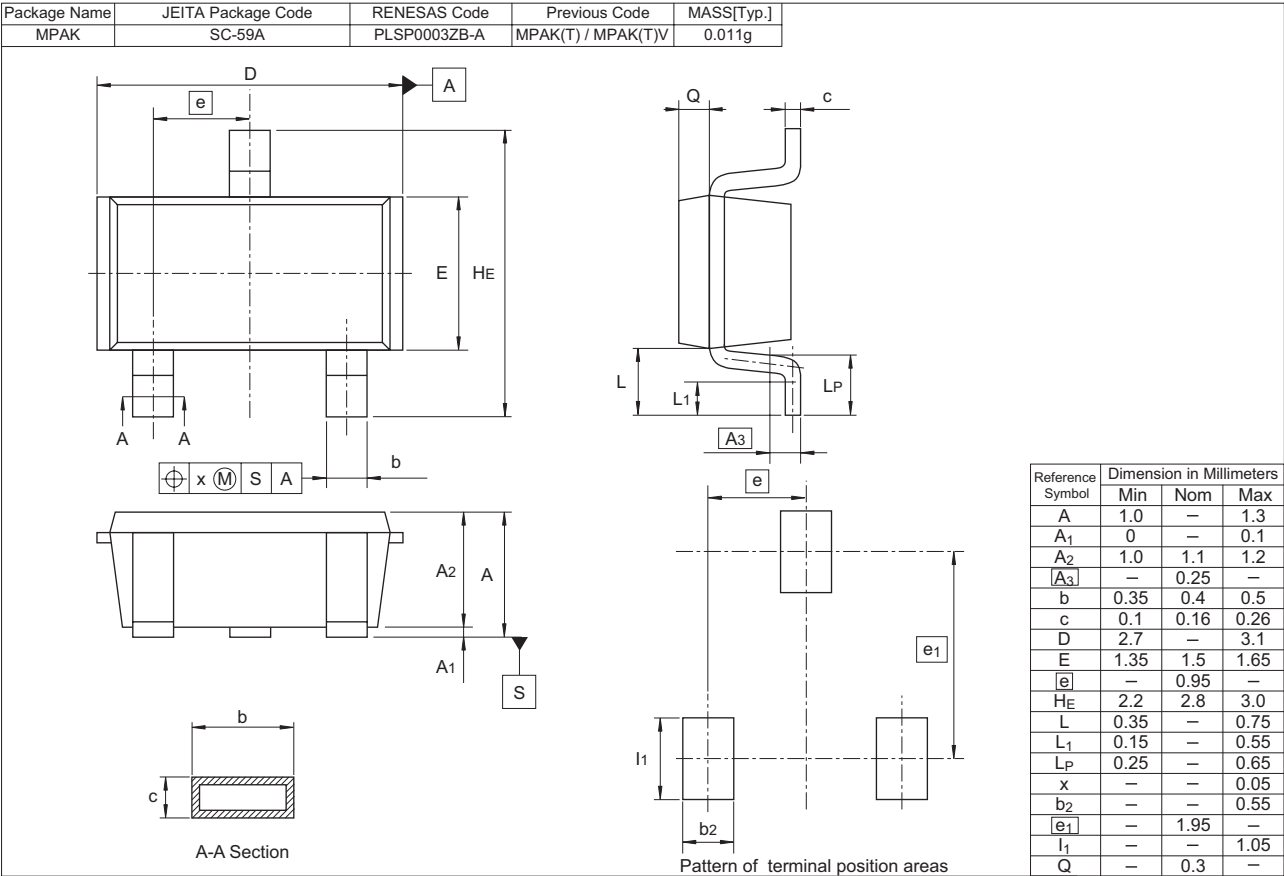
Switching Time Test Circuit



Waveform



Package Dimensions



Ordering Information

Part No.	Quantity	Shipping Container
RQK0604IGDQATL-E	3000 pcs.	φ178 mm reel, 8 mm Emboss taping

Notes:

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